

# **OPTIMIZED ARCHITECTURE FOR HIGH- PERFORMANCE BCD ADDITION IN DIGITAL SYSTEMS**

*A project report submitted in partial fulfillment of the requirements for the award of the*

*Degree of*

**MASTER OF TECHNOLOGY**

*in*

**VLSI DESIGNS**

**Submitted By**

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*Under the esteemed guidance of*

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(Deemed to be a university)  
(Estd. u/s 3 of UGC act 1956 & Accredited by NAAC with "A++" Grade)  
  
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**CERTIFICATE**

This is to certify that the project work entitled “**OPTIMIZED ARCHITECTURE FOR HIGH-PERFORMANCE BCD ADDITION IN DIGITAL SYSTEMS**” is a bona fide work carried out by **B AKSHAT RAO [2023004682]** submitted in partial fulfillment of the requirements for the award of the degree of Bachelor of Technology in **Electronics and Communication Engineering**, GITAM School of Technology, GITAM (Deemed to be University), Visakhapatnam during the academic year 2023-2025.

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**DECLARATION**

We here by declare that the project work entitled “**OPTIMIZED ARCHITECTURE FOR HIGH-PERFORMANCE BCD ADDITION IN DIGITAL SYSTEMS**” is an original work done in the Department of Electrical, Electronics and Communication Engineering, GITAM School of Technology, GITAM (Deemed to be University) submitted in partial fulfillment of the requirements for the award of the degree of **MTech in Electronics and Communication Engineering**. The work has not been submitted to any other college or university for the award of any degree or diploma.

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## **ABSTRACT:**

This project introduces a high-speed, correction-free Binary-Coded Decimal (BCD) adder implemented in Cadence Virtuoso using 45nm CMOS technology (gpdk045). Designed to overcome conventional correction-dependent architectures' latency and power inefficiencies, the proposed two-stage design integrates NAND-NAND logic optimization and a compact Carry Look-Ahead Adder (CLA), enabling parallel carry propagation and eliminating post-addition adjustments. Leveraging Cadence's toolchain, the adder achieves a power-delay product (PDP) of 7.15 fJ for 1-digit operands, surpassing existing designs by 36–53%. Key innovations include a 40–52% reduction in propagation delay and 68% lower power consumption, validated through transient analysis at 100 MHz with a 0.8V supply. The 45nm implementation minimizes leakage currents and employs a compact transistor layout (708 transistors in the optimized design), ensuring scalability for multi-digit operations. These advancements make the adder ideal for high-precision financial computing and energy-efficient IoT edge devices. By combining robust CMOS efficiency with a streamlined correction-free architecture, this work establishes a benchmark for modern VLSI systems, delivering rapid, accurate decimal arithmetic while maintaining low latency and ultra-low power operation. The results highlight its potential to address critical demands in applications requiring computational precision and energy sustainability.

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# CONTENTS

CHAPTER	DESCRIPTION	PAGE NO.
<b>CHAPTER 1</b>	<b>INTRODUCTION</b>	<b>1-10</b>
1.1	OBJECTIVES	2
1.2	HALF ADDER	4
1.3	FULL ADDER	5
1.4	4-BIT ADDER	6
1.5	BCD ADDER	7
1.6	BCD ADDER USING NAND-NAND IMPLEMENTATION	7
1.7	WHY WE USE NAND GATE LOGIC TO IMPLEMENT BCD ADDITION	8
1.8	ADVANTAGES OF NAND GATE TO DESIGN THE BCD ADDER	9
1.9	COMPARISONS WITH CLA-BASED ADDERS & NAND-NAND BCD ADDER	10
<b>CHAPTER 2</b>	<b>LITERATURE SURVEY</b>	<b>16-18</b>
2.1	HIGH-SPEED CORRECTION-FREE BCD ADDER USING CMOS TECHNOLOGY (01)	17
2.2	HIGH-SPEED GATE-LEVEL DECIMAL ADDITION TECHNIQUES (02)	17
2.3	NOVAL-BASED CLA ARCHITECTURE (03)	17

<b>CHAPTER</b>	<b>DESCRIPTION</b>	<b>PAGE NO.</b>
2.4	MULTI-CHANNEL TECHNIQUES (04)	18
2.5	COMPACT CLA DESIGN (05)	18
<b>CHAPTER 3</b>	<b>VIVADO IMPLEMENTATION OF BCD ADDER</b>	<b>14-22</b>
3.1	VIVADO IMPLEMENTATION OF BCD ADDER: DESCRIPTION & PURPOSE	15
3.2	BCD ADDER NETLIST 1 EQUATION	16
3.3	BCD ADDER NETLIST 2 EQUATION	17
3.4	VIVADO IMPLEMENTATION OF BCD ADDER	18-22
<b>CHAPTER 4</b>	<b>IMPLEMENTATION OF BCD ADDER</b>	<b>23-34</b>
4.1	BCD ADDER IMPLEMENTATION IN CADENCE VIRTUOSO	24
4.2	IMPLEMENTATION OF BCD ADDER	26
4.3	IMPLEMENTATION OF 1-DIGIT BCD ADDER	31
4.4	OUTPUT OF MODIFIED 1 DIGIT BCD ADDITION A=1010 & B=1000: - 0010	33
<b>CHAPTER 5</b>	<b>PROPOSED BCD ADDER</b>	<b>35-44</b>
5.1	LOGIC SIMPLIFICATION AND OPTIMIZATION	36
5.2	BOOLEAN EQUATION SIMPLIFICATION	36-40
5.3	IMPLEMENTATION OF MODIFIED PROPOSED BCD ADDER IN CDAENCE 45NM TECHNOLOGY	41-42

<b>CHAPTER</b>	<b>DESCRIPTION</b>	<b>PAGE NO.</b>
5.4	OUTPUT OF MODIFIED 1 DIGIT BCD ADDITION A=1010 & B=1000: - 0010	42
<b>CHAPTER 6</b>	<b>CONCLUSIONS AND FUTURE SCOPE</b>	<b>43-49</b>
6.1	CONCLUSION	46
6.2	FUTURE SCOPE	47-78
	<b>REFERENCE</b>	49

## **LIST OF FIGURES**

<b>FIG.NO</b>	<b>NAME OF THE FIGURE</b>	<b>PAGE NO.</b>
1.1	BLOCK DIAGRAM OF CONVENTIONAL 1-DIGIT BCD ADDER	2
1.2	HALF ADDER	4
1.3	FULL ADDER	5
1.4	4-BIT ADDER	6
3.1	VIVADO IMPLEMENTATION OF BCD EQUATION	21
4.1	IMPLEMENTATION OF CONVENTIONAL 1-DIGIT BCD ADDER	24
4.2	OUTPUT WAVEFORM OF CONVENTIONAL 1-DIGIT BCD ADEER	25
4.3	BLOCK DIAGRAM OF NETLIST 1 & 2	25
4.4	CIRCUIT DIAGRAM OF NETLIST 1	28
4.5	CIRCUIT DIAGRAM OF NETLIST 2	31
4.6	CADENCE IMPLEMENTATION OF BCD ADDER NETLIST 1&2	32
4.7	OUTPUT OF 1-DIGIT BCD ADDER	33
5.3	IMPLEMENTATION OF PROPOSED BCD ADDER	41
5.4	OUTPUT OF MODIFIED 1-DIGIT BCD ADDER	42

## LIST OF TABLES

TABLE NO.	NAME OF THE TABLE	PAGE NO.
1.1	TRUTH TABLE OF BCD ADDER	3
1.2	COMPARISON OF NAND-NAND VS. CLA BASED ADDER	10
3.1	BCD ADDER NETLSIT 1 EQUATION	16
3.2	BCD ADDER NETLIST 2 EQUATION	17
3.3	BCD ADDER NETLIST 1 & NETLIST 2 EQUATION	18
4.4	POWER DELAY AND TRANSISTOR COUNT OF BCD ADDER	34
5.1	ORIGINAL EQUATION OF NETLIST1	36
5.2	EQUATIONS OF NETLIST1	37
5.3	MODIFIED EQUATION OF NETLSIT 1	37
5.4	ORIGINAL EQUATIONS OF NETLIST 2	38
5.5	EQUATIONS OF NETLIST 2	39
5.6	SIMPLIFIED EQUATION NETLIST 2	40
5.7	DELAY POWER AND TRANSISTOR COUNT OF MODIFIED BCD ADDER	43
5.8	COMPARISON OF ALL 3 MODELS	44

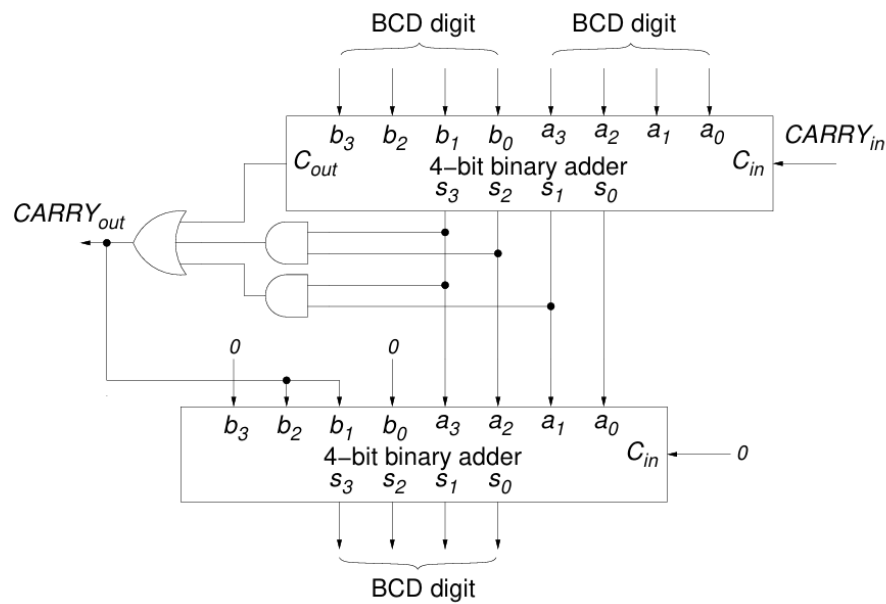


# **CHAPTER 1**

## **INTRODUCTION**

## 1.1 OBJECTIVES

The primary objective of this project is to design a high-speed Binary Coded Decimal (BCD) adder optimized for performance using CMOS technology. In digital systems, especially those involving financial, commercial, and real-time embedded applications, accurate and fast decimal computation is crucial. Due to complex correction logic and carry propagation, traditional BCD adders often suffer from higher delays and increased power consumption. To address these limitations, this project implements a BCD adder architecture incorporating Carry Lookahead Adder (CLA) logic for faster carry generation and an optimized transistor-level design using GPDK 45nm CMOS technology. The design is implemented and simulated in the Cadence Virtuoso environment, allowing precise control over layout, delay, area, and power metrics. Ultimately, the goal is to achieve a balance between speed, power efficiency, and accuracy, implementing bcd adder suitable for integration into modern high-performance digital circuits.



**Figure -1.1: BLOCK DIAGRAM OF CONVENTIONAL 1-DIGIT BCD ADDER**

The Binary Coded Decimal (BCD) adder plays a critical role in digital systems where numerical data needs to be represented and processed in decimal form. This project focuses on designing a high-speed BCD adder using CMOS technology, which is known for its Low power consumption and high noise immunity. The main objective is to enhance the speed and performance of conventional BCD adders by optimizing the circuit at the transistor level. By utilizing GPDK 45nm CMOS technology in Cadence Virtuoso, this design achieves improved delay and power metrics, making it suitable for real-time embedded and arithmetic applications.

**Table No. -1.1: TRUTH TABLE OF BCD ADDER**

Inputs				Output
$S_3$	$S_2$	$S_1$	$S_0$	Y
0	0	0	0	0
0	0	0	1	0
0	0	1	0	0
0	0	1	1	0
0	1	0	0	0
0	1	0	1	0
0	1	1	0	0
0	1	1	1	0
1	0	0	0	0
1	0	0	1	0
1	0	1	0	1
1	0	1	1	1
1	1	0	0	1
1	1	0	1	1
1	1	1	0	1
1	1	1	1	1

## 1.2 HALF ADDER

A half adder circuit is a digital circuit that performs the addition of two binary digits. It has two inputs, A and B, and two outputs, Sum and Carry. The Sum output represents the result of adding the two input bits together, while the Carry output represents any carry that occurs when adding the two bits. In a BCD Adder, the half adder circuit is used to add the first digits of the input numbers. The half adder circuit consists of two logic gates: an XOR gate and an AND gate. The XOR gate produces the Sum output, while the AND gate produces the Carry output. The circuit can be implemented using transistors or other electronic components. However, in modern digital electronics, it is often implemented using integrated circuits (ICs) or field-programmable gate arrays (FPGAs).

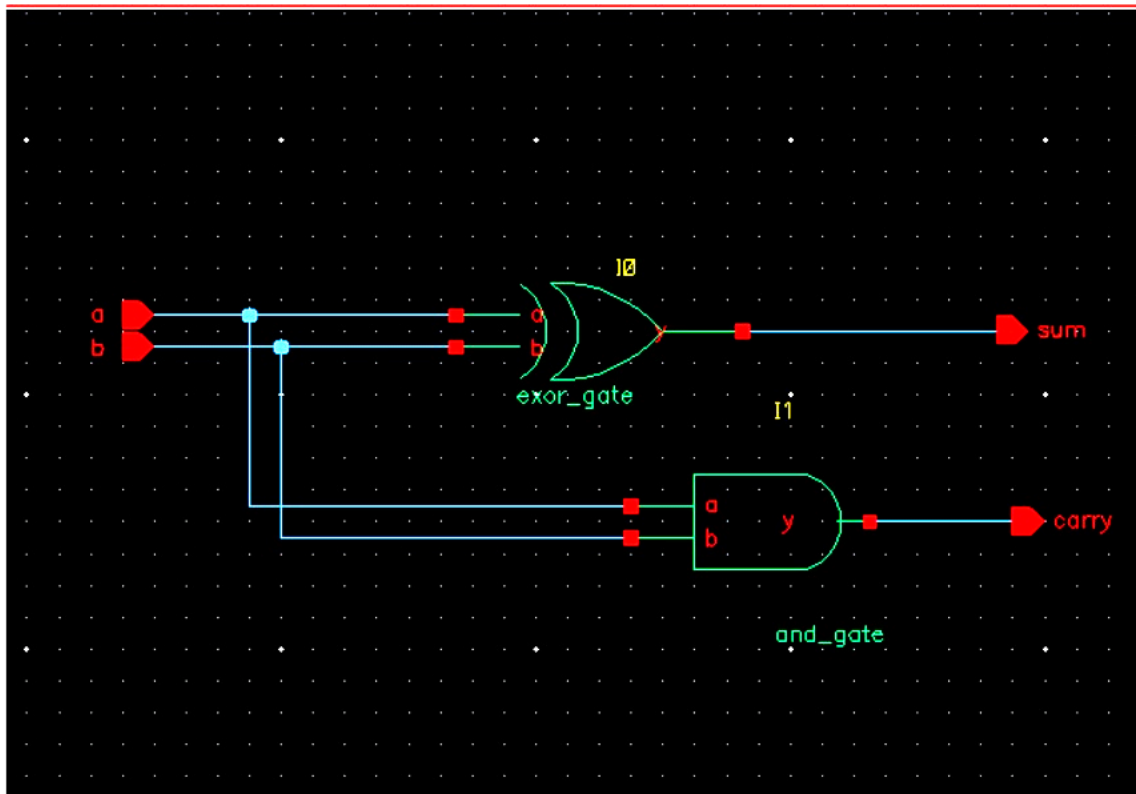


Figure -1.2: HALF ADDER

### 1.3 FULL ADDER

The full adder circuit is a fundamental component of the BCD adder. It adds two binary digits along with a carry-in bit to produce a sum and a carry-out bit. The circuit consists of multiple logic gates, including XOR, AND, and OR gates, connected in a specific manner to perform the addition operation. The full adder is designed to handle the addition of three bits, making it an essential building block for more complex arithmetic operations. In a BCD adder, the full adder circuit is used to add two BCD digits together. Since BCD digits can only range from 0 to 9, the circuit must detect when the result exceeds 9 and generate a carry-out bit. This is achieved by adding a layer of logic gates to the circuit, which compares the sum output to 9 and generates a carry-out bit if necessary. By using the full adder circuit in this way, the BCD adder can perform accurate and efficient arithmetic operations on BCD numbers.

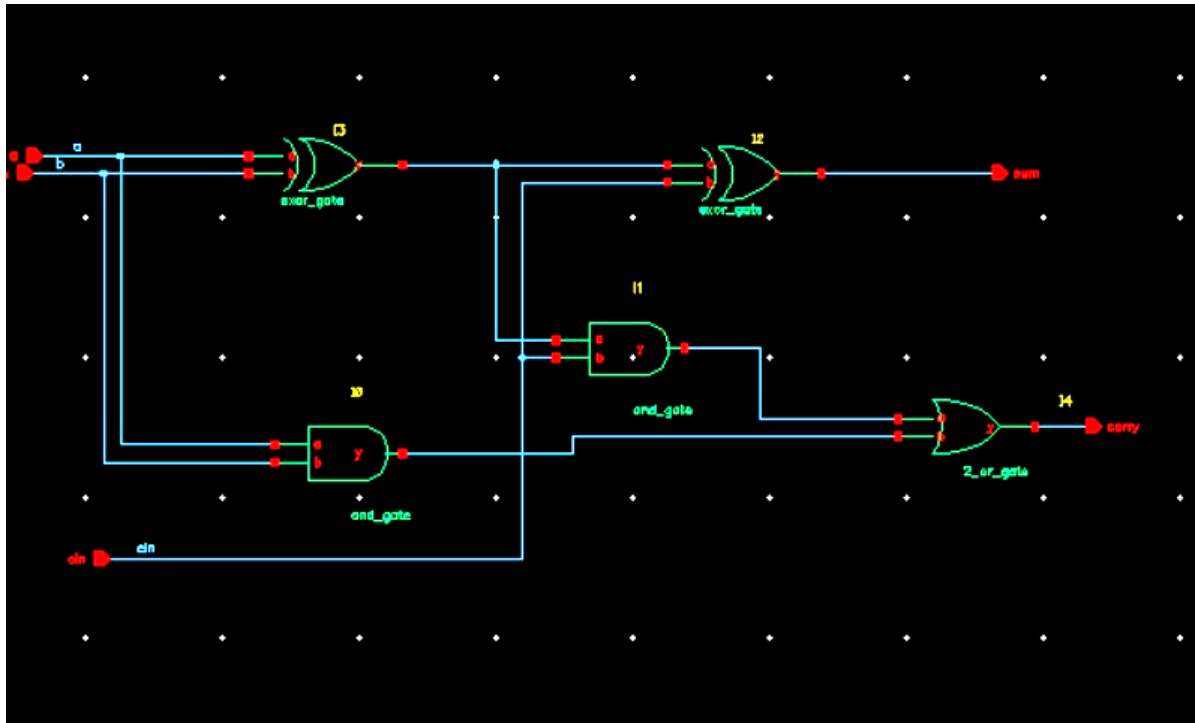
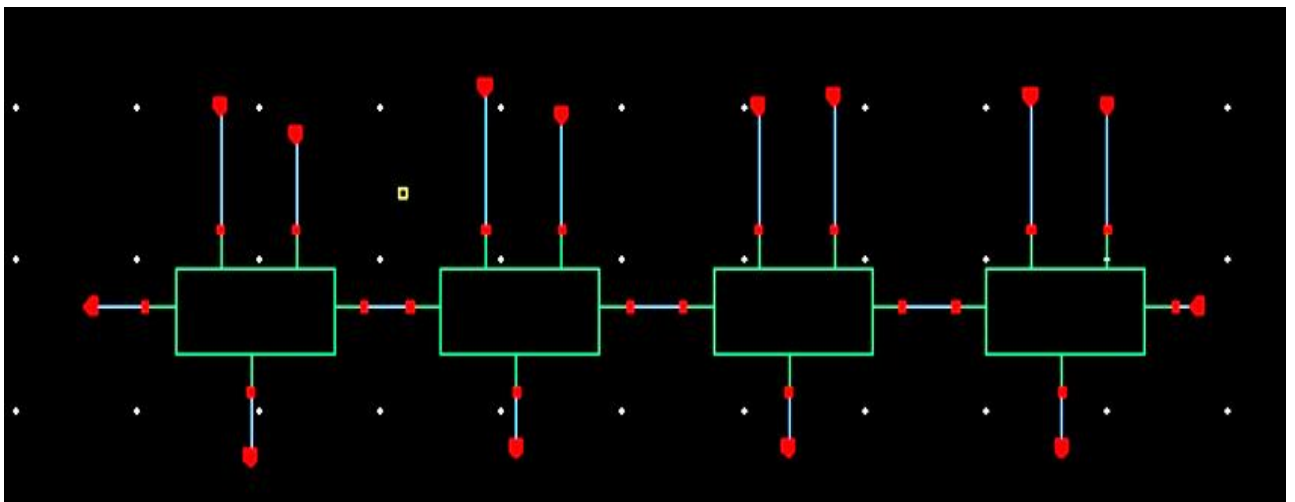


Figure -1.3: FULL ADDER

## 1.4 4-BIT ADDER

BCD Adder, or Binary Coded Decimal Adder, is a type of digital circuit that performs addition on two binary coded decimal numbers. In simpler terms, it's a device that adds two decimal numbers together using binary arithmetic. BCD Adder is an essential component in digital electronics, especially in applications where decimal arithmetic is required. The way the BCD Adder works is by taking two binary coded decimal numbers as input and adding them together using a combination of full adders and half adders. The result is then converted back into binary coded decimal format. This process allows for the addition of decimal numbers using binary arithmetic, which is much faster and more efficient than traditional decimal arithmetic.



**Figure -1.4: 4-BIT ADDER**

BCD Adder is a crucial component in digital electronics, enabling precise calculation of decimal numbers. Its importance lies in its ability to perform arithmetic operations on binary-coded decimal numbers, which are commonly used in various applications such as financial calculations, timekeeping, and data storage. The BCD Adder has revolutionized computing by providing an accurate and efficient way to perform calculations with decimal numbers. One of the most significant advantages of the BCD Adder is its accuracy. Unlike other adders that can introduce errors when performing calculations with decimal numbers, the BCD Adder ensures that the results are always correct. This makes it ideal for use in industries where precision is critical, such as finance and manufacturing. Additionally, the BCD Adder is highly efficient, allowing for faster processing times and reduced power consumption.

## 1.5 BCD ADDER

A conventional Binary-Coded Decimal (BCD) adder is a two-stage circuit designed to perform decimal arithmetic directly without binary-decimal conversions. It comprises two 4-bit binary adders and correction logic. The first adder computes the sum of two BCD digits and an input carry. If the intermediate result exceeds 9 (invalid BCD) or generates a carry-out, a correction step adds 6(0110) via the second adder to ensure a valid BCD output.

The conventional 1-digit BCD adder follows a two-stage binary addition with correction logic. It consists of:

### 1. First 4-bit Binary Adder:

Adds two 4-bit BCD digits ( $A_3A_2A_1A_0$  and  $B_3B_2B_1B_0$ ) and the carry-in ( $C_{in}$ ).

Outputs a preliminary sum ( $S_3'S_2'S_1'S_0'$ ) and carry-out ( $C_{out1}$ ).

### 2. Correction Logic:

Detects invalid BCD results ( $\text{sum} > 9$  or  $1=C_{out1}=1$ ).

Generates a correction signal to add 6 (0110) to the invalid sum.

### 3. Second 4-bit Binary Adder:

Adds 0110 to the preliminary sum if correction is required.

Outputs the final BCD sum ( $S_3S_2S_1S_0$ ) and carry-out ( $C_{out}$ ).

## 1.6 BCD ADDER USING NAND-NAND IMPLEMENTATION

### OBJECTIVE

BCD adder using only NAND gates to eliminate correction logic, reduce transistor count, and improve power-delay performance. Correction-Free Architecture: Avoids post-addition correction (adding 6) by integrating validation into the logic. Universal NAND Logic: All gates (AND, OR, XOR) are implemented using NAND gates. CMOS Compatibility Simulated in 45nm, 65nm, and 180nm nodes for scalability.

### BCD ADDER DESIGN

Inputs and Outputs

Inputs: Two 4-bit BCD digits:  $A=A_3A_2A_1A_0$ ,  $B=B_3B_2B_1B_0$ , Carry-in:  $C_{in}$ .

Outputs: 4-bit BCD sum:  $S=S_3S_2S_1S_0$ , Carry-out: Count.

## Two-Stage Netlist Architecture

The BCD adder is split into two netlists:

Netlist1: Computes intermediate sum  $K=J+I$ , where:

$J=A_3A_2A_1$ ,  $I=B_3B_2B_1$ .

Outputs:  $K_3K_2K_1K_0$ .

Netlist2: Adds  $A_0+B_0+C_{in}$  to  $2 \times K$ , generating the final BCD sum  $S$  and  $c_{out}$

## 1.7 WHY WE USE NAND GATE LOGIC TO IMPLEMENT BCD ADDITION

The choice of NAND gates for implementing the BCD adder is driven by their unique advantages in digital circuit design, particularly for CMOS technology.

### UNIVERSALITY OF NAND GATES

NAND gates are universal gates, meaning they can implement any Boolean logic function (AND, OR, NOT, XOR) using only NAND gates.

### CMOS EFFICIENCY

In CMOS technology, NAND gates are inherently efficient in terms of power, area, and speed.

### TRANSISTOR COUNT

A 2-input NAND gate uses 4 transistors (2 PMOS + 2 NMOS), compared to 6 transistors for an AND gate.

### POWER CONSUMPTION

NAND gates consume power only during switching, making them suitable for low-power applications such as IoT.

### SPEED

NAND gates have faster propagation delays than AND/OR gates due to fewer transistor stages.

### CORRECTION-FREE ARCHITECTURE

Traditional BCD adders require a two-stage correction logic, whereas the NAND-NAND implementation integrates this validation directly into the Boolean equations, eliminating the need for separate correction steps.

**Netlist1: Computes intermediate sum  $K=J+I$  while checking for overflow.**

**Netlist2: Combines  $K$  with  $A_0$ ,  $B_0$ , and  $C_{in}$  to generate valid BCD outputs.**

Example:

For  $A=9_{BCD}$  and  $B=7_{BCD}$ :

Netlist1 computes  $K=J+I=6$ .

Netlist2 calculates  $S=2 \times 6 + (1+0+0) = 13_{BCD}$ .

## **1.8 ADVANTAGES OF NAND GATES TO DESIGN THE BCD ADDER**

The NAND-NAND implementation outperforms Carry Look-Ahead (CLA) logic for BCD adders due to its simplified architecture, superior CMOS efficiency, and elimination of correction overheads.

### **UNIVERSAL GATE FLEXIBILITY**

**NAND Advantage: Single Gate Type:** NAND gates can replicate all logic functions (AND, OR, XOR), enabling a homogeneous design.

**Simplified Fabrication:** No need for mixed-gate libraries (e.g., CLA's AND/OR/XOR), reducing layout complexity.

**CLA Limitation:** Requires multiple gate types, increasing fabrication costs and verification effort.

### **CMOS EFFICIENCY**

**NAND Advantage: Lower Transistor Count:** A 2-input NAND uses 4 transistors vs. 6 for an AND/OR gate.

**Power Efficiency:** NAND gates dissipate power only during switching, ideal for low-power IoT/edge devices.

**CLA Limitation:** Mixed-gate designs (AND/OR/XOR) have higher leakage currents and dynamic power.

### **CORRECTION-FREE DESIGN**

**NAND Advantage: - Integrated Validation:** The correction step (adding 6 if  $\text{sum} > 9$ ) is embedded directly into the Boolean equations of Netlist1 and Netlist2, eliminating sequential correction stages.

NAND Implementation: Directly computes  $S=16 \rightarrow 16+6=22$  BCD in one stage.

CLA Implementation: Requires two stages (sum + correction), adding delay.

CLA Limitation: Extra Logic: Post-addition correction adds latency and transistor overhead

**SCALABILITY:**

NAND Advantage: Validated across 45nm, 65nm, and 180nm CMOS nodes, ensuring compatibility with modern and legacy systems. Operates at 1V supply for ultra-low-power edge computing.

CLA Limitation: Mixed gates suffer from threshold voltage mismatches in scaled nodes.

**Table No.1.2: COMPARISON OF NAND-NAND VS. CLA-BASED ADDERS**

ASPECT	NAND-NAND BCD ADDER	CLA-BASED BCD ADDER
Gate Uniformity	Single gate type (NAND) simplifies fabrication.	Mixed gates (AND/OR/XOR) increase complexity.
Transistor Count	Lower (470 transistors for 1-digit).	Higher (366–500 for CLA + correction logic).
Power Efficiency	Lower static power (CMOS switching only).	Higher dynamic power due to mixed gates.
Educational Focus	Emphasizes Boolean algebra fundamentals.	Abstracted logic hides gate-level details.

## **CHAPTER 2**

### **LITERATURE SURVEY**

## **2.1. HIGH-SPEED CORRECTION-FREE BCD ADDER USING CMOS TECHNOLOGY**

**Reference:** Al-Share et al. (01)

**Description:**

This work proposes a novel two-stage, correction-free BCD adder designed using CMOS technology, eliminating the need for traditional post-addition correction circuits. The design splits the addition process into two netlists (Netlist1 and Netlist2) to interleave correction logic within the computation, significantly reducing critical path delays. Implemented in 45nm, 65nm, and 180nm CMOS technologies, the adder achieves superior performance in Power Delay Product (PDP)—e.g., **13.88 fJ** for 3-digit operands compared to **25.38 fJ** for existing designs. The architecture leverages optimized NAND-NAND logic and dynamic CMOS gates, validated through LTSPICE simulations.

## **2.2. HIGH-SPEED GATE-LEVEL DECIMAL ADDITION TECHNIQUES**

**Reference:** Schmookler and Weinberger (02)

**Description:**

This foundational work pioneered gate-level optimizations for decimal arithmetic, specifically targeting Binary-Coded Decimal (BCD) adders. By minimizing logical redundancies and critical path delays, the authors achieved significant improvements in computational speed. Their methodology emphasized efficient circuit design for financial and scientific applications, where decimal precision and latency reduction are critical. This study laid the groundwork for subsequent research on high-performance decimal arithmetic units.

## **2.3. NOVEL CLA ARCHITECTURE WITH NOR-BASED PROPAGATE SIGNALS**

**Reference:** Miao and Li (03)

**Description:**

This study introduced a modified 4-bit Carry Look-Ahead (CLA) adder by replacing conventional XOR gates with NOR-based logic for propagate signal generation. The redesigned CLA reduced circuit complexity and propagation delay, enabling faster carry generation. Boolean functions were redefined to leverage inverted generated signals, streamlining the carry chain. The resulting architecture improved speed and power efficiency, influencing subsequent CMOS adder designs through innovative logic-level optimizations.

## 2.4. MULTI-CHANNEL TECHNIQUES FOR REDUCED TRANSISTOR COUNT

**Reference:** Siddhamshitiwar (04)

**Description:**

Focusing on static power reduction, this work redesigned a 32-bit BCD adder using multi-channel CMOS techniques. By halving the transistor count compared to traditional designs (14 vs. 28 transistors) and integrating power gating, the adder achieved substantial power savings. The methodology emphasized scalability for large-scale applications, demonstrating how simplified architectures could enhance energy efficiency without compromising functionality. This approach is particularly relevant for portable and energy-constrained systems.

## 2.5. COMPACT 4-BIT CARRY LOOK-AHEAD (CLA) ARCHITECTURE

**Reference:** Ruiz and Granda (05)

**Description:**

This work introduced a **compact 4-bit CLA adder** that simplifies carry generation by eliminating the need for explicit Generate ( $G_i$ ) signals. Instead, it relies solely on Propagate ( $P_i$ ) signals derived through optimized logic gates. The design reduces circuit complexity and transistor count compared to conventional CLAs, achieving comparable speed with lower power consumption.

## **CHAPTER 3**

### **VIVADO IMPLEMENTATION OF BCD ADDER**

### 3.1 VIVADO IMPLEMENTATION OF BCD ADDER: DESCRIPTION & PURPOSE

#### WHAT WAS DONE?

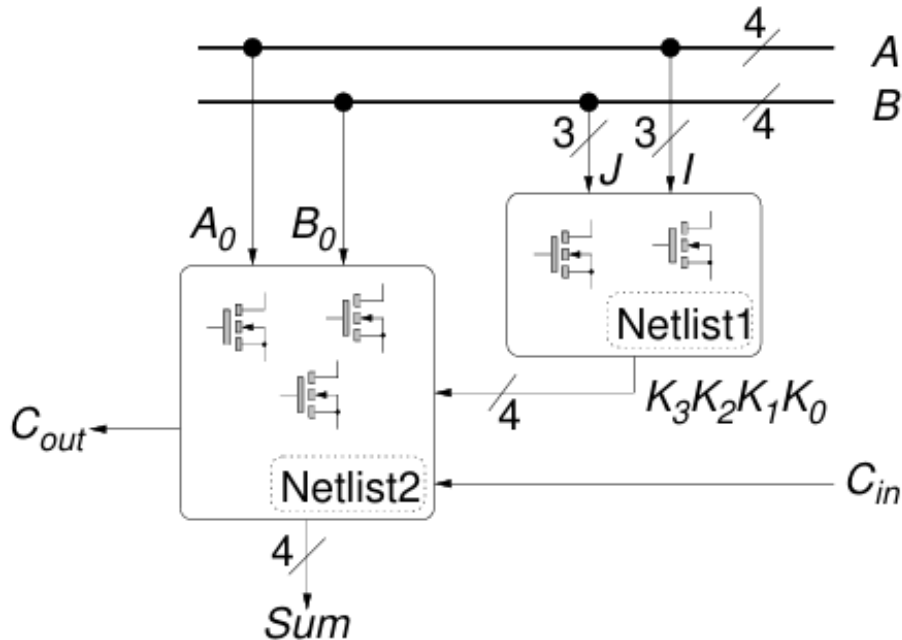
The Vivado implementation of the BCD adder involved:

Verilog Code: Writing RTL (Register Transfer Level) code for the BCD adder's logic (Netlist1 and Netlist2 equations).

Testbench: Creating a testbench to simulate the adder's functionality with predefined inputs (e.g., A=1001, B=0100).

Functional Verification: Running simulations to validate whether the adder produces correct BCD outputs and carry signals.

Debugging: Checking for logical errors in the Boolean equations before ASIC implementation in Cadence.



**Figure 3.1: NETLIST1& NETLIST 2 BLOCK DIAGRAM**

## WHY WAS VIVADO IMPLEMENTATION NECESSARY?

Functional Validation:

To ensure the Boolean equations (Netlist1 and Netlist2) work as intended.

Early Error Detection:

Identify and fix logical errors (e.g., incorrect gate connections, missing terms) before physical design in Cadence.

Proof of Concept:

Confirm that the correction-free architecture eliminates the need for the "+6 adjustment" seen in conventional BCD adders

### 3.2 NETLIST 1 EQUATIONS:

Computes  $K=J+I$ , where  $J=A_3A_2A_1$  and  $I=B_3B_2B_1$ .

Inputs:  $A_3, A_2, A_1, B_3, B_2, B_1$ .

Outputs:  $K_3, K_2, K_1, K_0$ .

Intermediate Variables ( $X_0$  to  $X_{24}$ ). These variables are derived from the inputs A and B:

**Table no -3.1: NETLIST 1 EQUATION**

$X_0 = \overline{A_3}A_2A_1B_2B_1$	$X_{13}=A_3B_2B_1$
$X_1 = A_1\overline{B_3}B_2\overline{B_1}$	$X_{14}=\overline{A_3}A_2A_1B_3$
$X_2 = \overline{A_3}A_1\overline{B_2}B_1$	$X_{15}=A_3 \overline{B_3}B_2\overline{B_1}$
$X_3 = \overline{A_3}A_1B_2\overline{B_1}$	$X_{16}=A_2 \overline{A_1}B_2 \overline{B_1}$
$X_4 = A_2A_1B_2B_1$	$X_{17}=A_2A_1\overline{B_2}B_1$
$X_5 = A_2\overline{A_1}B_3$	$X_{18}=\overline{A_2}A_1B_2B_1$
$X_6 = A_3B_2 \overline{B_1}$	$X_{19}=A_2A_1B_2$
$X_7=A_3B_3$	$X_{20}=A_2\overline{A_1}B_3$
$X_8=A_2 \overline{B_3}B_2\overline{B_1}$	$X_{21}=A_2B_2B_1$

$X9 = \overline{A3A2B2} \overline{B1}$	$X22 = A3B2\overline{B1}$
$X10 = A2 \overline{A1} \overline{B2}B1$	$X23 = A1B3$
$X11 = \overline{A2}A1\overline{B2}B1$	$X24 = A3B1$
$X12 = A2A1B3$	

### 3.3 NETLIST 2 EQUATIONS:

Purpose: Adds  $A0+B0+ Cin$  to  $2 \times K$ .

Inputs:  $K3, K2, K1, K0, A0, B0, Cin$ .

Outputs:  $S3, S2, S1, S0, Cout$ .

Intermediate Variables ( $Y_0$  to  $Y_{26}$ ) These variables combine  $K, A0, B0$ , and  $Cin$

**Table no -3.2: NETLIST 2 EQUATION**

$Y0 = \overline{CINA0B0}$	$Y13 = K1\overline{CINB0}$
$Y1 = \overline{CINA0B0}$	$Y14 = K1\overline{CINA0}$
$Y2 = \overline{CINA0B0}$	$Y15 = K1\overline{A0B0}$
$Y3 = CINA0B0$	$Y16 = K1\overline{K0}$
$Y4 = \overline{K2K0CINB0}$	$Y17 = K1K0CINB0$
$Y5 = \overline{K2K0CINA0}$	$Y18 = K1K0CINA0$
$Y6 = \overline{K2K0A0B0}$	$Y19 = K1K0A0B0$
$Y7 = K0\overline{A0B0}$	$Y20 = K2\overline{CINB0}$
$Y8 = K0\overline{CINB0}$	$Y21 = K2\overline{CINA0}$
$Y9 = K0\overline{CINA0}$	$Y22 = K2\overline{A0B0}$
$Y10 = \overline{K1K0CINB0}$	$Y23 = K2CINB0$
$Y11 = \overline{K1K0CINA0}$	$Y24 = K2CINA0$

$Y_{12} = \overline{K_1 K_0 A_0 B_0}$	$Y_{25} = K_2 A_0 B_0; Y_{26} = K_3$
---------------------------------------	--------------------------------------

**Table no -3.3: NETLIST 1&2 EQUATION**

NETLSIT 1	NETLIST 2
$K_0 = \overline{X_0 \cdot X_1 \cdot X_2 \cdot X_3 \cdot X_4 \cdot X_5 \cdot X_6 \cdot X_7}$	$S_1 = \overline{Y_4 \cdot Y_5 \cdot Y_6 \cdot Y_7 \cdot Y_8 \cdot Y_9}$
$K_1 = \overline{X_0 \cdot X_8 \cdot X_9 \cdot X_{10} \cdot X_{11} \cdot X_{12} \cdot X_{13} \cdot X_7}$	$S_2 = \overline{Y_{10} \cdot Y_{11} \cdot Y_{12} \cdot Y_{13} \cdot Y_{14} \cdot Y_{15} \cdot Y_{16}}$
$K_2 = \overline{X_{14} \cdot X_{15} \cdot X_{16} \cdot X_{17} \cdot X_{18}}$	$S_3 = \overline{Y_{17} \cdot Y_{18} \cdot Y_{19} \cdot Y_{20} \cdot Y_{21} \cdot Y_{22}}$
$K_3 = \overline{X_{19} \cdot X_{20} \cdot X_{21} \cdot (X_{22} \cdot X_{23}) \cdot X_{24} \cdot X_7}$	$COUT = S_1 = \overline{Y_{23} \cdot Y_{24} \cdot Y_{25} \cdot Y_{26}}$

### 3.4 VIVADO IMPLEMENTATION OF NETLIST 1 AND NETLIST 2 FOR BCD ADDER

```

module BCD_Adder_1Digit (
    input [3:0] A,
    input [3:0] B,
    input Cin,
    output [3:0] Sum,
    output Cout);

    wire X0, X1, X2, X3, X4, X5, X6, X7, X8, X9, X10, X11, X12;
    wire X14, X15, X16, X17, X18, X19, X20, X21, X22, X23, X24;
    wire K0, K1, K2, K3;

    assign X0 = A [3] & A [2] & A [1] & B [2] & B [1];
    assign X1 = A [3] & A [1] & B [2] & B [1];

```

```

assign X2 = A [2] & A [1] & B [2] & B [1];
assign X3 = A[3] & B[2] & B[1];
assign X4 = A[2] & B[3] & B[2] & B[1];
assign X5 = A[2] & A[1] & B[2] & B[1];
assign X6 = A[2] & A[1] & B[3];
assign X7 = A[3] & A[2] & A[1] & B[3];
assign X8 = A[2] & A[1] & B[2] & B[1];
assign X9 = A[2] & A[1] & B[2] & B[1];
assign X10 = A[2] & A[1] & B[3];
assign X11 = A[3] & B[2] & B[1];
assign X12 = A[3] & B[1];
assign X14 = A[3] & A[2] & A[1] & B[3];
assign X15 = A[2] & A[1] & B[2] & B[1];
assign X16 = A[2] & A[1] & B[2] & B[1];
assign X17 = A[2] & A[1] & B[3];
assign X18 = A[2] & A[1] & B[2] & B[1];
assign X19 = A[3] & B[2] & B[1];
assign X20 = A[2] & A[1] & B[3];
assign X21 = A[3] & B[2] & B[1];
assign X22 = A[3] & B[1];
assign X23 = A[3] & B[1];
assign X24 = A[3] & B[1];
assign K0 = X0 & X1 & X2 & X3 & X4 & X5 & X6 & X7;
assign K1 = X0 & X8 & X9 & X10 & X11 & X12 & X7;
assign K2 = X14 & X15 & X16 & X17 & X18;

```

```

assign K3 = X19 & X20 & X21 & (X22 & X23) & X24 & X7;

wire Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7, Y8, Y9, Y10, Y11, Y12, Y13;

wire S0, S1, S2, S3;

assign Y0 = Cin & A[0] & B[0];
assign Y1 = Cin & A[0] & B[0];
assign Y2 = K2 & K0 & Cin & B[0];
assign Y3 = K2 & K0 & A[0] & B[0];
assign Y4 = K0 & Cin & B[0];
assign Y5 = K1 & K0 & Cin & B[0];
assign Y6 = K1 & K0 & A[0] & B[0];
assign Y7 = K1 & Cin & A[0];
assign Y8 = K1 & K0;
assign Y9 = K1 & K0 & Cin & A[0];
assign Y10 = K2 & Cin & B[0];
assign Y11 = K2 & A[0] & B[0];
assign Y12 = K2 & Cin & A[0];
assign Y13 = K3;

assign S0 = Y0 & Y1 & Y2 & Y3;
assign S1 = Y4 & Y5 & Y6 & Y7 & Y8 & Y9;
assign S2 = Y10 & Y11 & Y12 & Y13;
assign S3 = K3;

assign Sum = {S3, S2, S1, S0};

assign Cout = K3;

end

endmodule

```

```

module Netlist1_TB;

reg [3:0] A, B;

wire [3:0] K;

wire [4:0] TK;

wire [3:0] S;

wire Count;

Netlist1 uut1 (.A(A), .B(B), .K(K), .TK(TK));

Netlist2 uut2 (

.K3(TK[3]), .K2(TK[2]), .K1(TK[1]), .K0(TK[0]),

.A0(A[0]), .B0(B[0]), .Cin(TK[4]),

.S(S), .Cout(Cout));

initial begin

    A = 4'b1001; B = 4'b0100;

    #100;

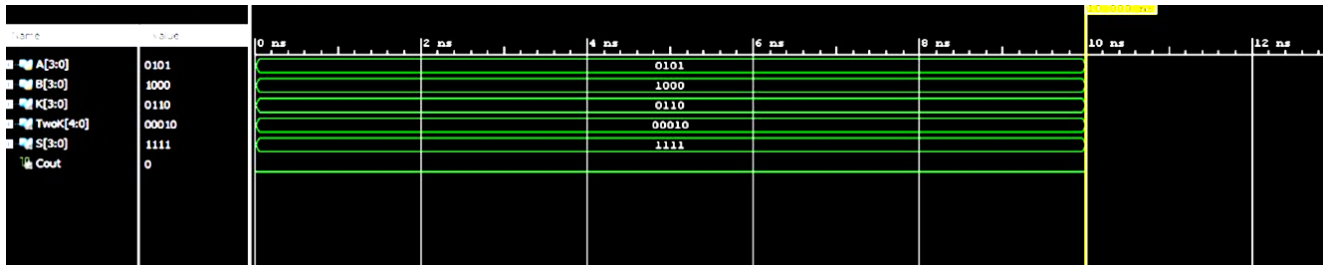
    $display ("Sum = %b, Cout = %b", S, Cout);

    $finish;

end

endmodule

```



**Figure3.2: VIVADO IMPLEMENTATION OF BCD EQUATION**

The Vivado implementation of the BCD adder equations of netlist 1 and netlist 2 BCD addition of A=0101 & B=1000: - 0010

The Boolean equations for Netlist1 and Netlist2 were implemented in Vivado to functionally verify their correctness and ensure the proposed correction-free logic operates as intended before ASIC fabrication.

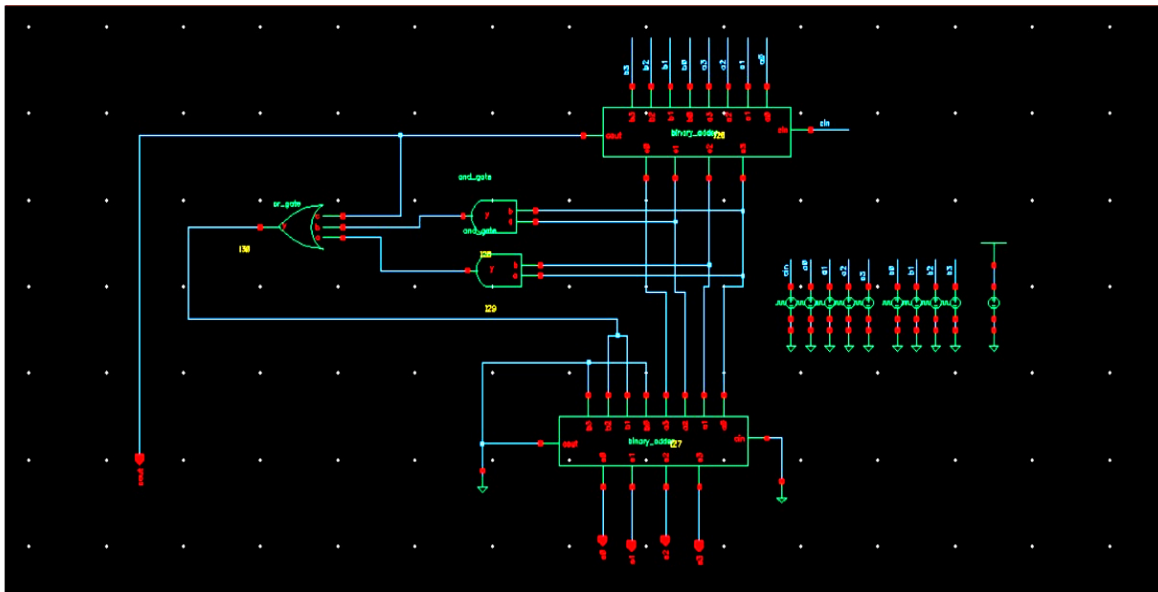
## **CHAPTER 4**

### **IMPLEMENTATION OF BCD ADDER**

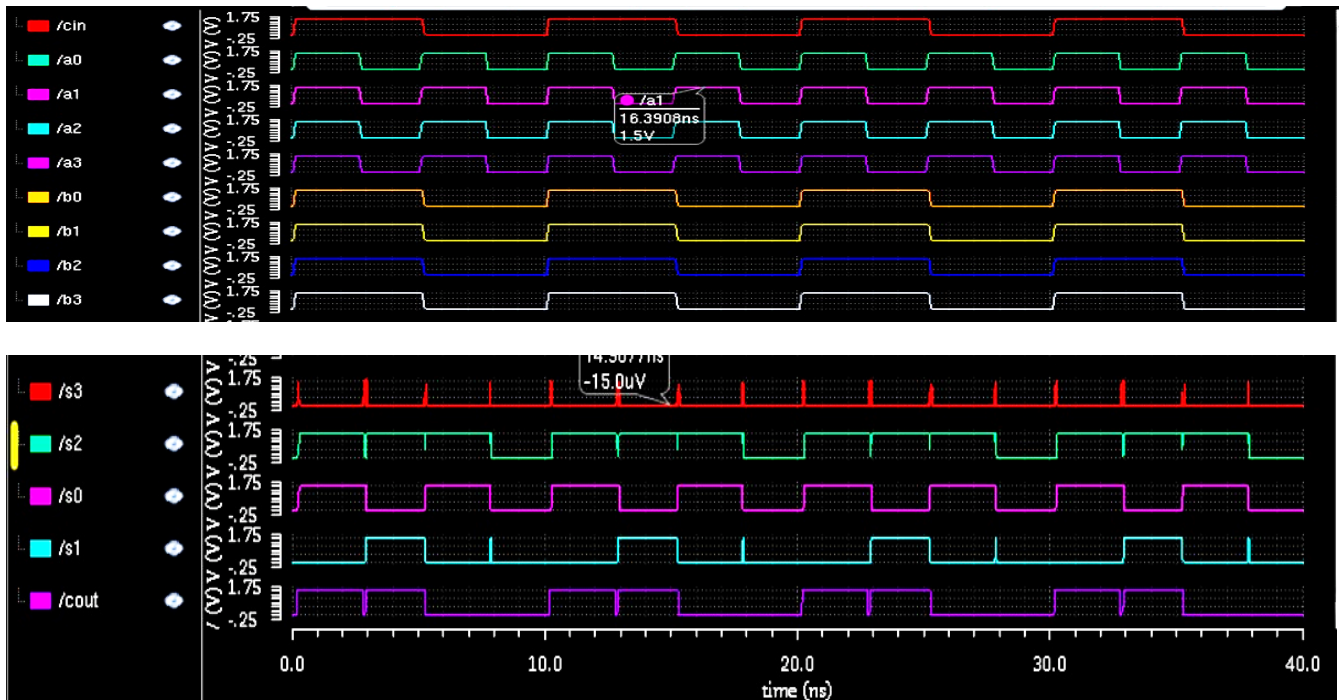
## 4.1 BCD ADDER IMPLEMENTATION IN CADENCE VIRTUOSO

BCD Adder is a digital circuit used to perform the addition of two binary-coded decimal numbers. It works by adding each digit of the two numbers, generating a sum and a carry bit for each digit. The sum bits are combined to form the result, while the carry bits are used to propagate the carry to the next digit. A BCD Adder can be implemented using logic gates such as AND, OR, XOR, and NAND gates.

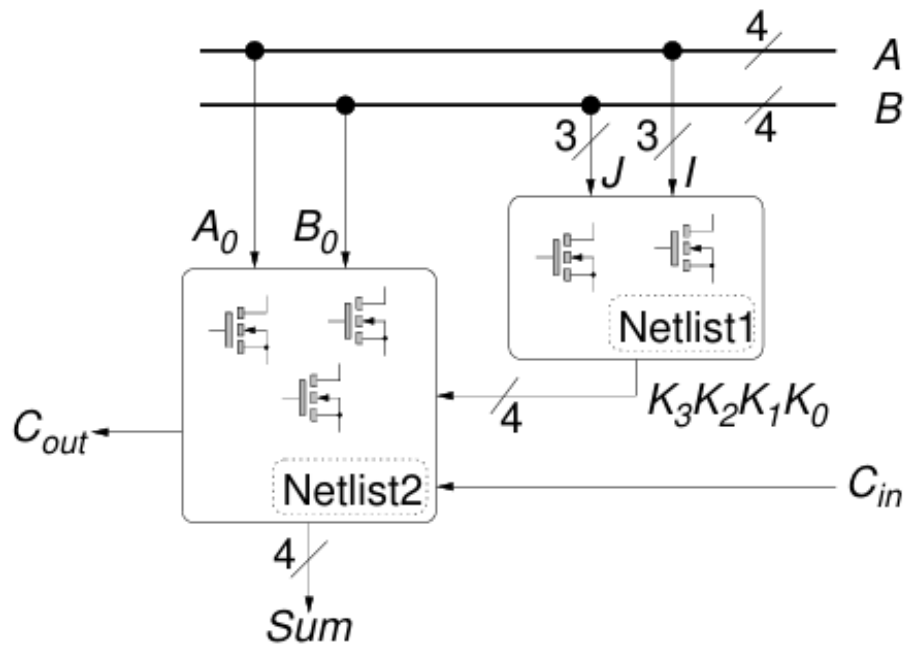
For example, consider the addition of two BCD numbers:  $45 + 23$ . To perform this addition using a BCD Adder, we first convert the numbers to their binary equivalents: 01000101 and 00100011. We then add the two numbers using a BCD Adder, which gives us the result 01100100 in binary, or 68 in decimal. This process can be repeated for any two BCD numbers.



**Figure -4.1: IMPLEMENTATION OF CONVENTIONAL 1-DIGIT BCD ADDER**



**Figure 4.2: OUTPUT WAVEFORM OF CONVENTIONAL 1-DIGIT BCD ADDER**



**Figure 4.3: NETLIST1& NETLIST 2 BLOCK DIAGRAM**

## 4.2 IMPLEMENTATION OF BCD ADDER

The implementation of the BCD Adder is a high-speed, correction-free CMOS-based circuit designed to perform decimal addition directly in hardware. It eliminates the need for post-addition correction, significantly reducing latency and power consumption. This design is scalable for multi-digit operands (1–4 digits) and has been validated across 45nm CMOS technologies.

The adder employs a two-stage netlist architecture, splitting the computation into two optimized logic blocks:

### NETLIST1

Function: Computes  $K=J+I$ , where:

$J=A_3A_2A_1$  (upper 3 bits of input A)

$I=B_3B_2B_1$  (upper 3 bits of input B)

Output: Generates  $K_3, K_2, K_1, K_0$ , where  $2 \times K$  is an even decimal digit (LSB = 0).

Logic: Optimized NAND-NAND implementation (Equation 9 in the paper).

Example: For  $A=5$  (01010101),  $J=2$ ; for  $B=8$  (10001000),  $I=4$ .

$K=J+I=6$ , so  $2 \times K=12$  (1001010010BCD).

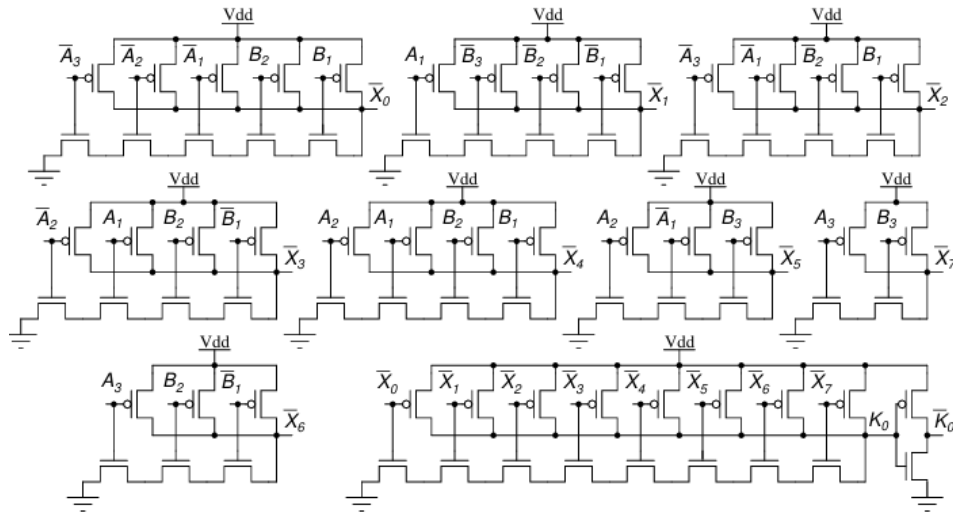
### NETLIST2

Function: Adds  $A_0+B_0+C_{in}$  to  $2 \times K$ .

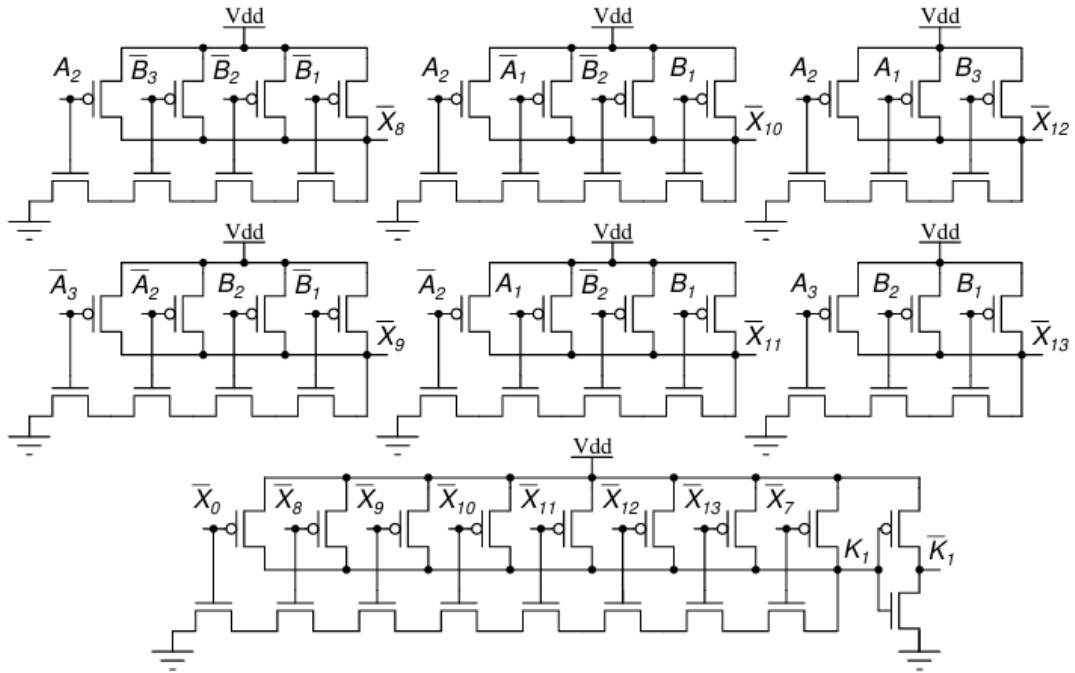
Output: Final BCD sum ( $S_3S_2S_1S_0$ ) and carry-out ( $C_{out}$ ).

Logic: Optimized NAND-NAND logic.

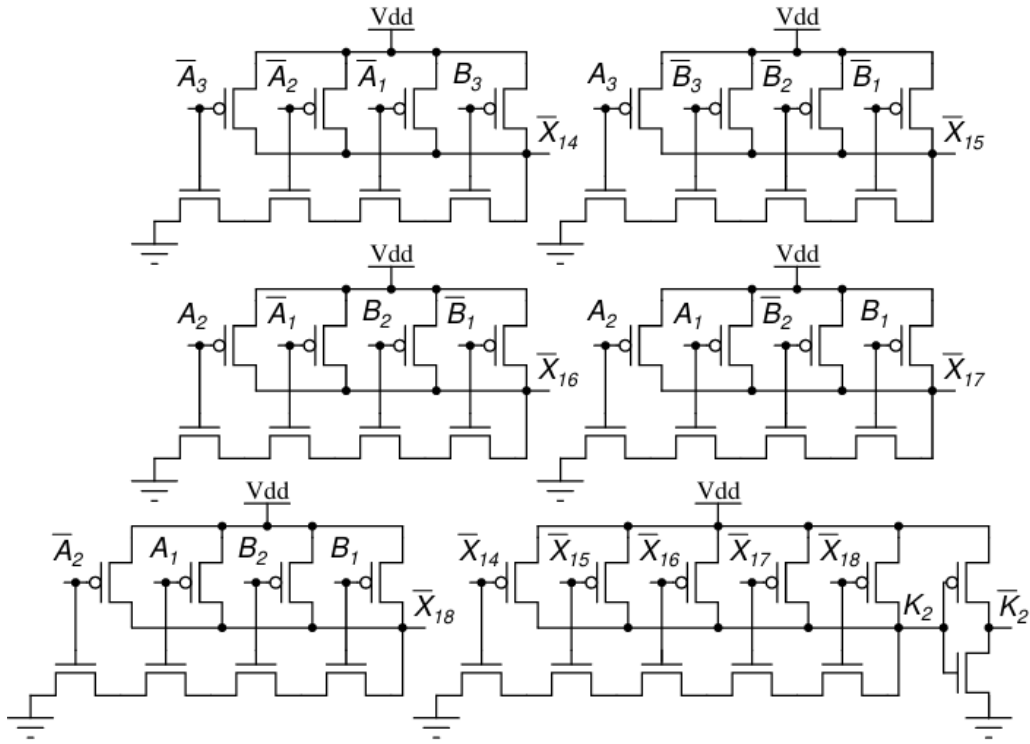
Example: If  $A_0=1, B_0=1, C_{in}=0$ , and  $2 \times K=12$ : Total sum =  $12+1+1+0=14$  (10101010BCD),  $C_{out}=1$ .



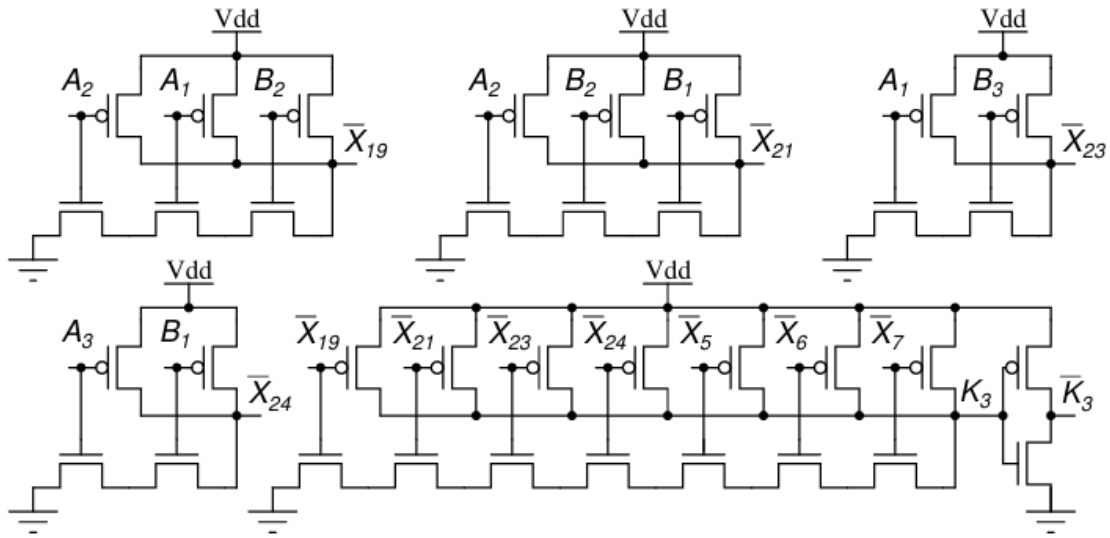
(a) output  $K_0$



(b) output  $K_1$

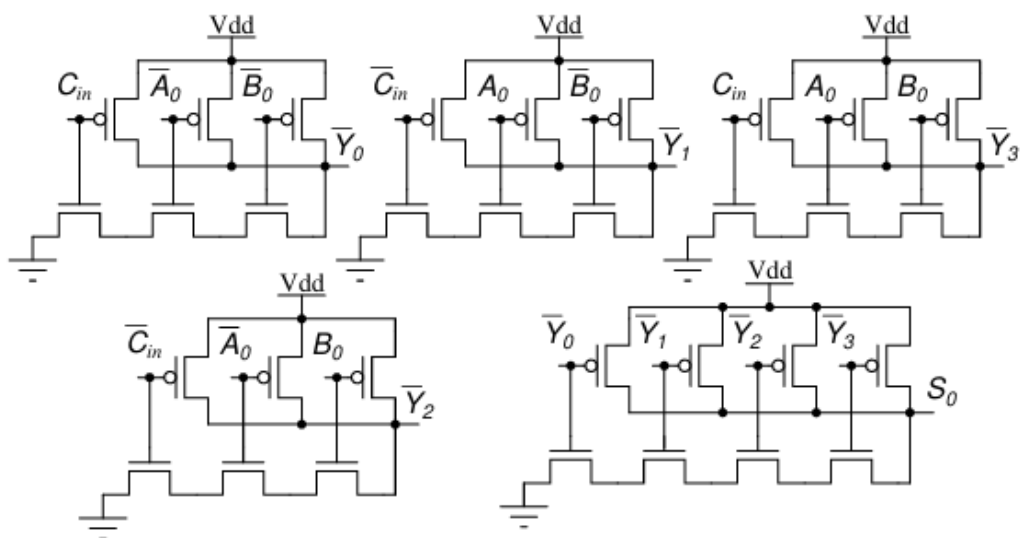


(c) output  $K_2$

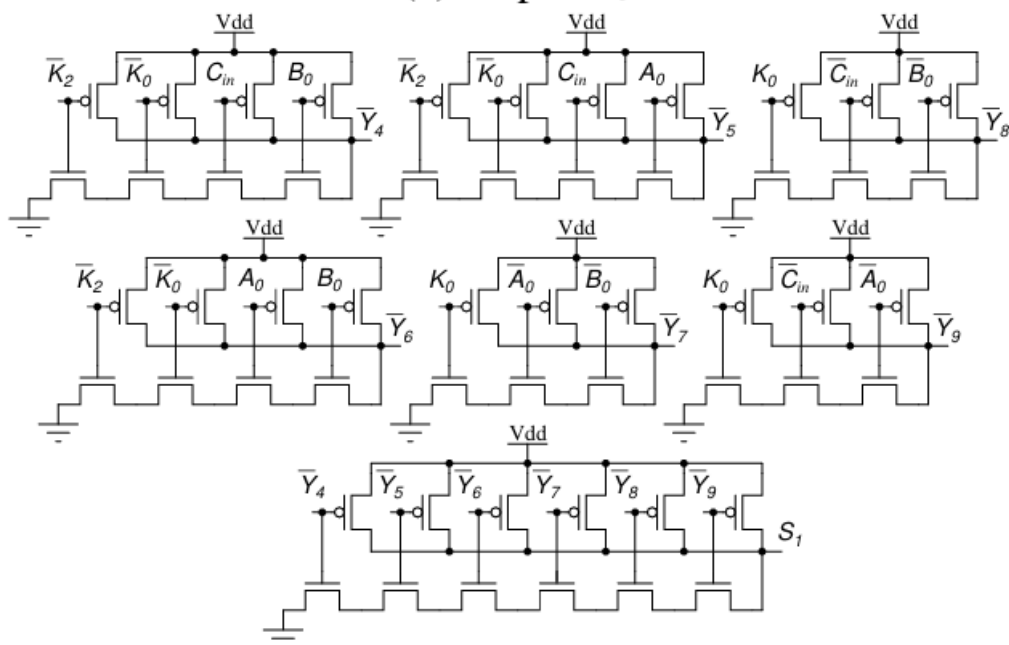


(d) output  $K_3$

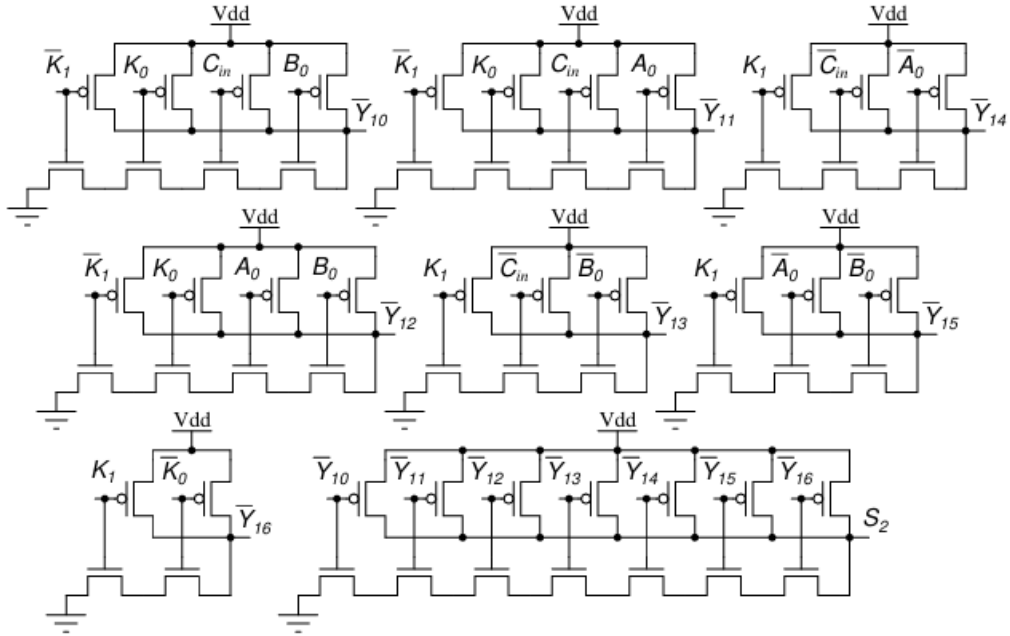
**Figure -4.4: CIRCUIT DIAGRAM OF NETLIST 1**



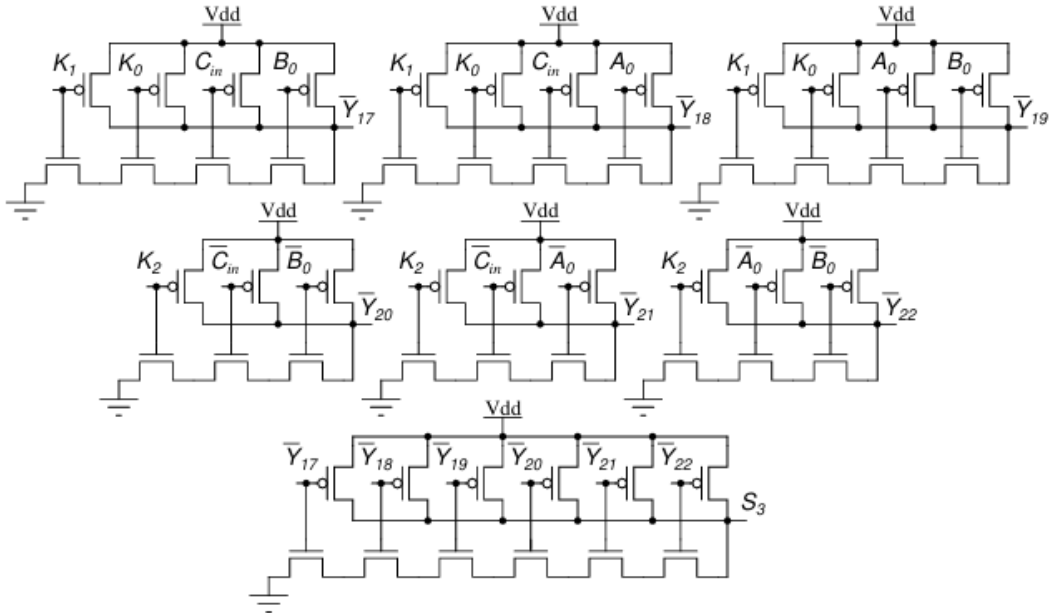
(a) output  $S_0$



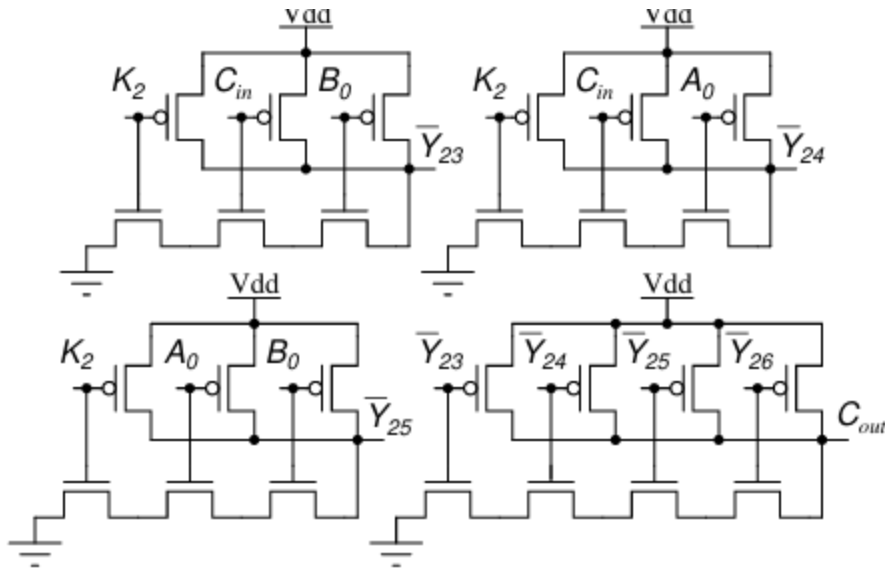
(b) output  $S_1$



(c) output  $S_2$



(d) output  $S_3$



(e) output  $C_{out}$

**Figure -4.5: CIRCUIT DIAGRAM OF NETLIST 2**

### 4.3 CADENCE IMPLEMENTATION OF 1-DIGIT BCD ADDER

#### NETLIST1: COMPUTATION OF $K=J+I$

Function:

Inputs: Upper 3 bits of operands A ( $A_3A_2A_1$ ) and B ( $B_3B_2B_1$ ).

Outputs:  $K_3$ ,  $K_2$ ,  $K_1$ ,  $K_0$ , representing  $2 \times K$ , where  $K=J+I$ .

Purpose: Precomputes the sum of the upper 3 bits of the operands to generate an intermediate even decimal digit.

Implementation Details (gpd045):

Logic:

Optimized NAND-NAND logic derived from Boolean equations.

Transistor Sizing:

PMOS: 270nm width, 45nm length.

NMOS: 135nm width, 45nm length.

## NETLIST2: FINAL SUM GENERATION

Function:

Inputs: K3K2K1K0, A0, B0, and Cin.

Outputs: Final BCD sum (S3S2S1S0) and carry-out (Cout).

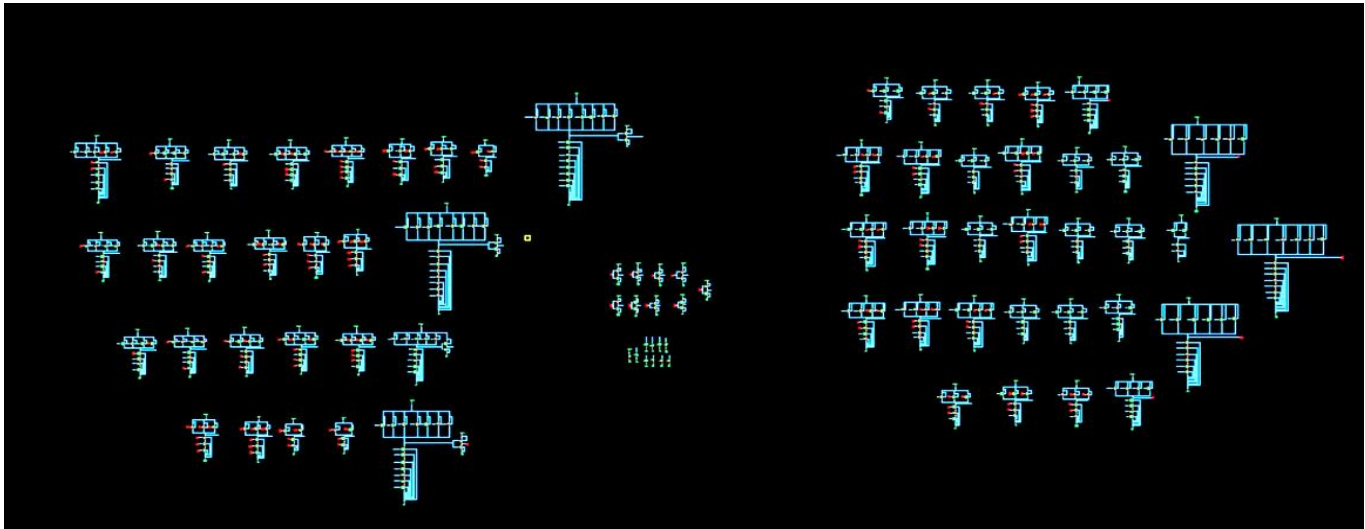
Purpose: Combines  $2 \times K$  with the lower bits (A0, B0) and carry-in to produce the valid BCD result.

Implementation Details (gpdK045):

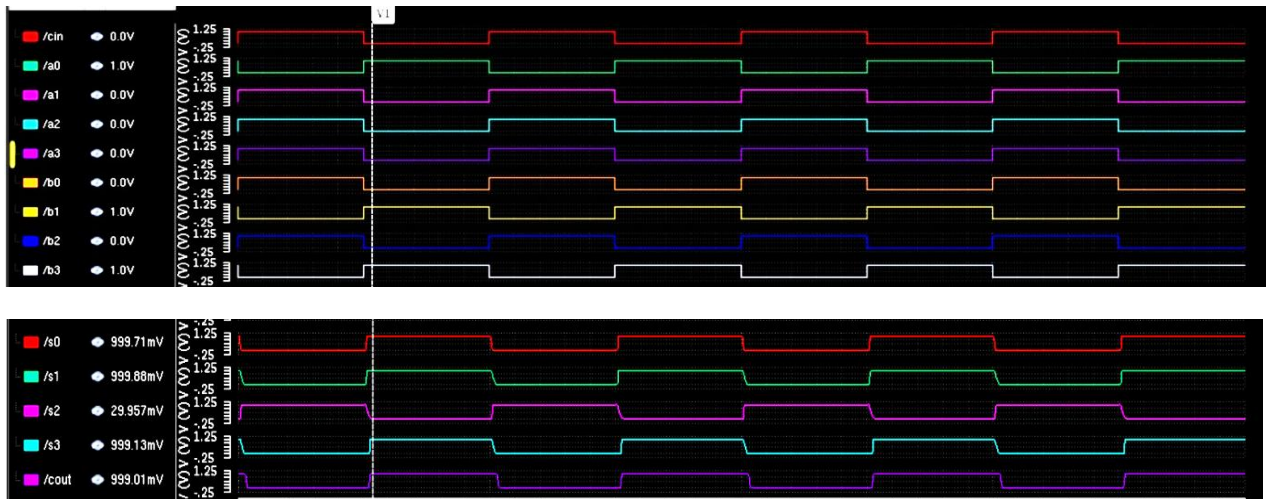
Logic:

NAND-NAND logic based on Equation 10 ( $S0=Y0 \cdot Y1 \cdot Y2 \cdot Y3$ , where  $Y0=CinA0B0$ ).

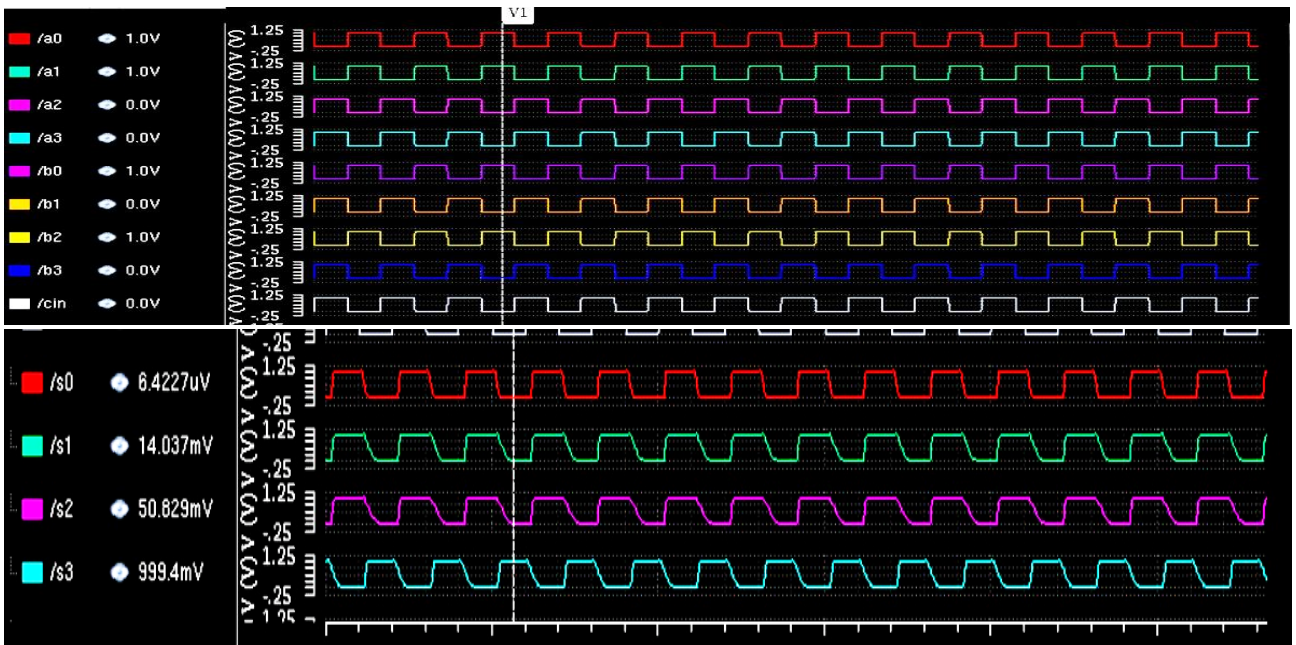
Transistor Sizing: Matches Netlist1 for consistency (270nm PMOS, 135nm NMOS).



**Figure -4.6: CADENCE IMPEMENTATION OF BCD ADDER  
NETLIST 1 & NETLIST 2**



**Figure 4.7: OUTPUT OF 1 DIGIT BCD ADDITION OF A=1000  
B=0101: 0010**



**Figure -4.8: OUTPUT OF 1 DIGIT BCD ADDITION OF A=0011  
B=0101: 1000**

**Table No:4.4 POWER DELAY AND TRANSISTOR COUNT OF  
IMPLEMENTATION OF BCD ADDER**

DELAY OF CIN-COUT	687.42 Pico sec
DELAY OF A0-COUT	584.47 Pico sec
DELAY OF B0-COUT	848.54 Pico sec
POWER OF IMPLEMENTATION OF BCD ADDER	44 nano watts
TRANSISTOR COUNT OF NMOS AND PMOS	$505+505=1010$

## **CHAPTER 5**

### **PROPOSED BCD ADDER**

## 5.1. LOGIC SIMPLIFICATION AND OPTIMIZATION

### OBJECTIVE:

The original BCD adder design (Netlist1 and Netlist2) contained redundant logic terms and complex Boolean equations, resulting in a higher transistor count, increased propagation delay, and higher power consumption.

Goal: Simplify the equations, eliminate redundancies, and optimize CMOS implementation for improved speed, power efficiency, and scalability.

### KEY MODIFICATIONS:

Logic Simplification: Merged overlapping terms in Netlist1 and Netlist2.

Transistor Reduction: Eliminated redundant gates.

Dynamic CMOS Optimization: Reduced leakage power through improved transistor sizing.

## 5.2. BOOLEAN EQUATION SIMPLIFICATION

### NETLIST1 (ORIGINAL VS. MODIFIED)

#### ORIGINAL EQUATIONS (PAPER):

**Table No. 5.1 ORIGINAL EQUATIONS OF NETLSIT 1**

NETLSIT 1
$K0 = \overline{\overline{X0 \cdot X1 \cdot X2 \cdot X3 \cdot X4 \cdot X5 \cdot X6 \cdot X7}}$
$K1 = \overline{\overline{X0 \cdot X8 \cdot X9 \cdot X10 \cdot X11 \cdot X12 \cdot X13 \cdot X7}}$
$K2 = \overline{\overline{X14 \cdot X15 \cdot X16 \cdot X17 \cdot X18}}$
$K3 = \overline{\overline{X19 \cdot X20 \cdot X21 \cdot (X22 \cdot X23) \cdot X24 \cdot X7}}$

**Table No. 5.2: EQUATIONS OF NETLSIT 1**

$X0 = \overline{A3A2A1B2B}$	$X13=A3B2B1$
$X1 = A1\overline{B3B2B1}$	$X14= \overline{A3A2A1B3}$
$X2 = \overline{A3A1B2B1}$	$X15=A3 \overline{B3B2B1}$
$X2 = \overline{A3A1B2B1}$	$X16=A2 \overline{A1B2 B1}$
$X4 = A2A1B2B1$	$X17=A2A1\overline{B2B1}$
$X5 = A2A1B3$	$X18= \overline{A2A1B2B1}$
$X6 = A3B2 \overline{B1}$	$X19=A2A1B2$
$X7=A3B3$	$X20=A2\overline{A1B3}$
$X8=A2 \overline{B3B2B1}$	$X21=A2B2B1$
$X9= \overline{A3A2B2 B1}$	$X22=A3B2\overline{B1}$
$X10=A2 \overline{A1 B2B1}$	$X23=A1B3$
$X11= \overline{A2A1B2B1}$	$X24=A3B1$
$X12=A2A1B3$	

**MODIFIED EQUATIONS:**

**Table No.5.3: MODIFIED EQUATIONS OF NETLSIT 1**

NETLSIT 1
$K0=\overline{X0 + X1 + X2 + X3 + X4 + X5 + X6 + X7}$
$K1=\overline{X0 + X8 + X9 + X10 + X11 + X12 + X13 + X7}$
$K2=\overline{X14 + X15 + X16 + X17 + X18}$
$K3=\overline{X19 + X20 + X21 + (X22 + X23) + X24 + X7}$

**TO SIMPLIFY THE EQUATIONS, WE DEFINE INTERMEDIATE VARIABLES  
Z1, Z2, Z3, Z4, Z5**

$$Z1 = \overline{A3.A2.A1}$$

$$Z2 = A2.A1$$

$$Z3 = A3.B2. \overline{B1}$$

$$Z4 = A2. \overline{A1}$$

$$Z5 = A2.B2.B1$$

Reduction: 8 terms  $\rightarrow$  5 terms

**NETLIST2 (ORIGINAL VS. MODIFIED)**

**ORIGINAL EQUATIONS (PAPER):**

**Table No.5.4: ORIGINAL EQUATIONS OF NETLSIT 2**

NETLIST 2
$S1 = \overline{Y4.Y5.Y6.Y7.Y8.Y9}$
$S2 = \overline{Y10.Y11.Y12.Y13.Y14.Y15.Y16}$
$S3 = \overline{Y17.Y18.Y19.Y20.Y21.Y22}$
$COU = \overline{Y23.Y24.Y25.Y26.}$

**Table No.5.5: EQUATIONS OF NETLSIT 2**

$Y0 = CINA0B0$	$Y13 = K1CINB0$
$Y1 = CINA0B0$	$Y14 = K1CINA0$
$Y2 = CINA0B0$	$Y15 = K1A0B0$
$Y3 = CINA0B0$	$Y16 = K1K0$
$Y4 = K2K0CINB0$	$Y17 = K1K0CINB0$
$Y5 = K2K0CINA0$	$Y18 = K1K0CINA0$
$Y6 = K2K0A0B0$	$Y19 = K1K0A0B0$
$Y7 = K0A0B0$	$Y20 = K2CINB0$
$Y8 = K0CINB0$	$Y21 = K2CINA0$
$Y9 = K0CINA0$	$Y22 = K2A0B0$
$Y10 = K1K0CINB0$	$Y23 = K2CINB0$
$Y11 = K1K0CINA0$	$Y24 = K2CINA0$
$Y12 = K1K0A0B0$	$Y25 = K2A0B0; Y26 = K3$

FOR S1 HAS A MIX OF COMPLEMENTED AND NON-COMPLEMENTED TERMS. DE MORGAN'S LAW CANNOT DIRECTLY SIMPLIFY THIS, AS IT REQUIRES ALL TERMS TO BE EITHER COMPLEMENTED OR NON-COMPLEMENTED TERMS

#### MODIFIED EQUATIONS:

Merged redundant terms and leveraged shared logic.

Simplified S0, S1, S2, S3, COUT EQUATIONS

INTERMEDIATE VARIABLE FOR Y TERMS:

TO SIMPLIFY THE EQUATIONS, WE DEFINE INTERMEDIATE VARIABLES W1, W2, W3, W4, W5, W6:

$$W1 = K0.CIN$$

$$W2 = K1.CIN$$

$$W3 = K2.CIN$$

$$W4 = K0.A0.B0$$

$$W5 = K1.A0.B0$$

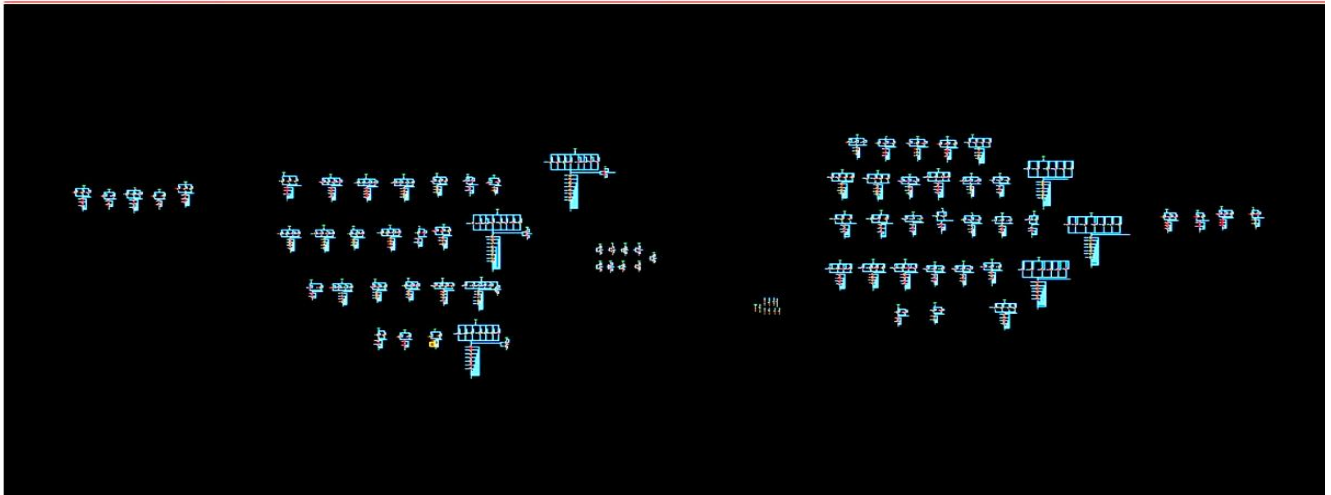
$$W6 = K2.A0.B0$$

**Table No 5.6: SIMPLIFIED EQUATIONS NETLIST 2**

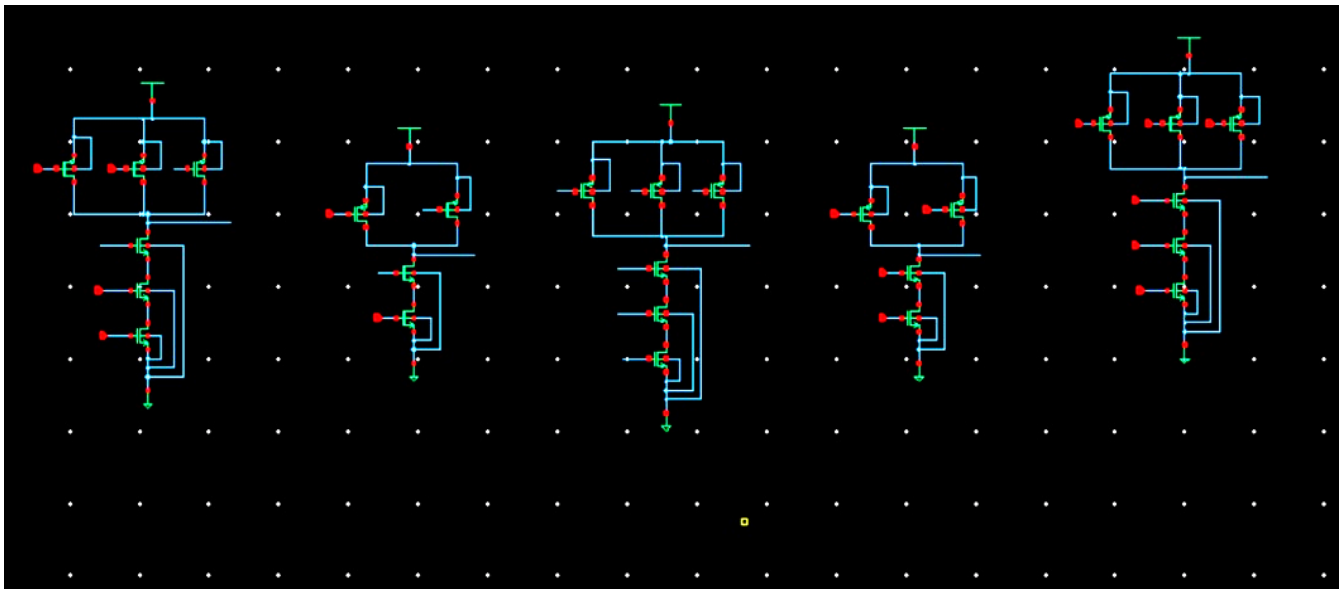
NETLIST 2
$S1 = \overline{\overline{Y4.Y5.Y6.Y7.Y8.Y9}}$
$S2 = \overline{\overline{Y10 + Y11 + Y12 + Y13 + Y14 + Y15 + Y16}}$
$S3 = \overline{\overline{Y17 + Y18 + Y19 + Y20 + Y21 + Y22}}$
$COUT = \overline{\overline{Y23 + Y24 + Y25 + Y26}}$

- Reduction: 6 terms  $\rightarrow$  3 terms.

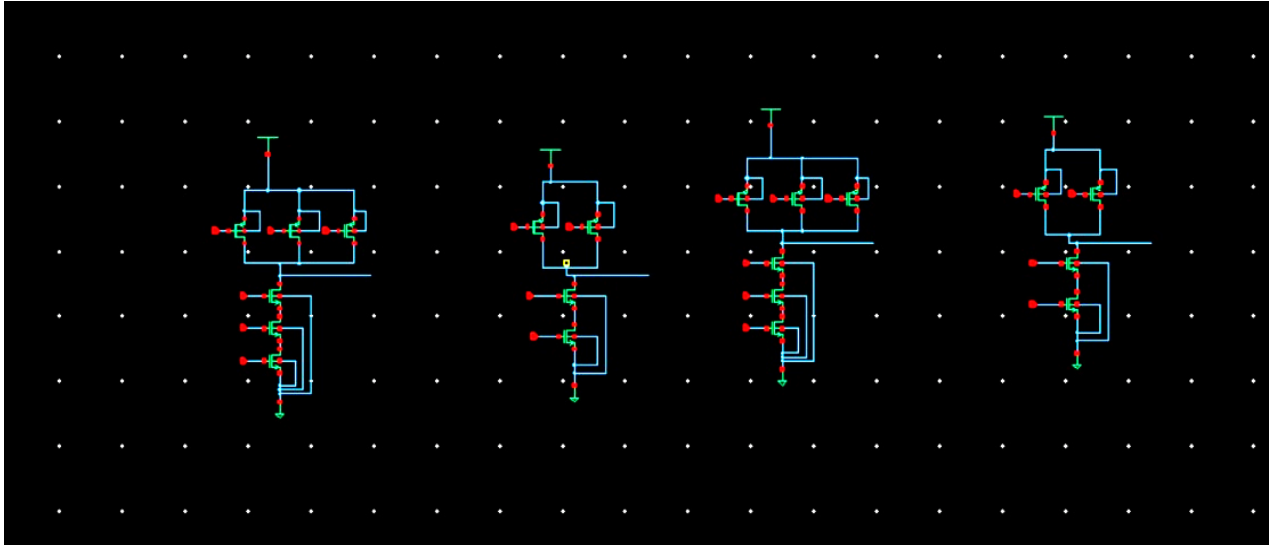
### 5.3 IMPLEMENTATION OF MODIFIED PROPOSED BCD ADDER IN CDAENCE 45NM TECHNOLOGY



**Figure -5.1: CADENCE IMPLEMENTATION OF MODIFIED  
NETLIST 1 & 2**

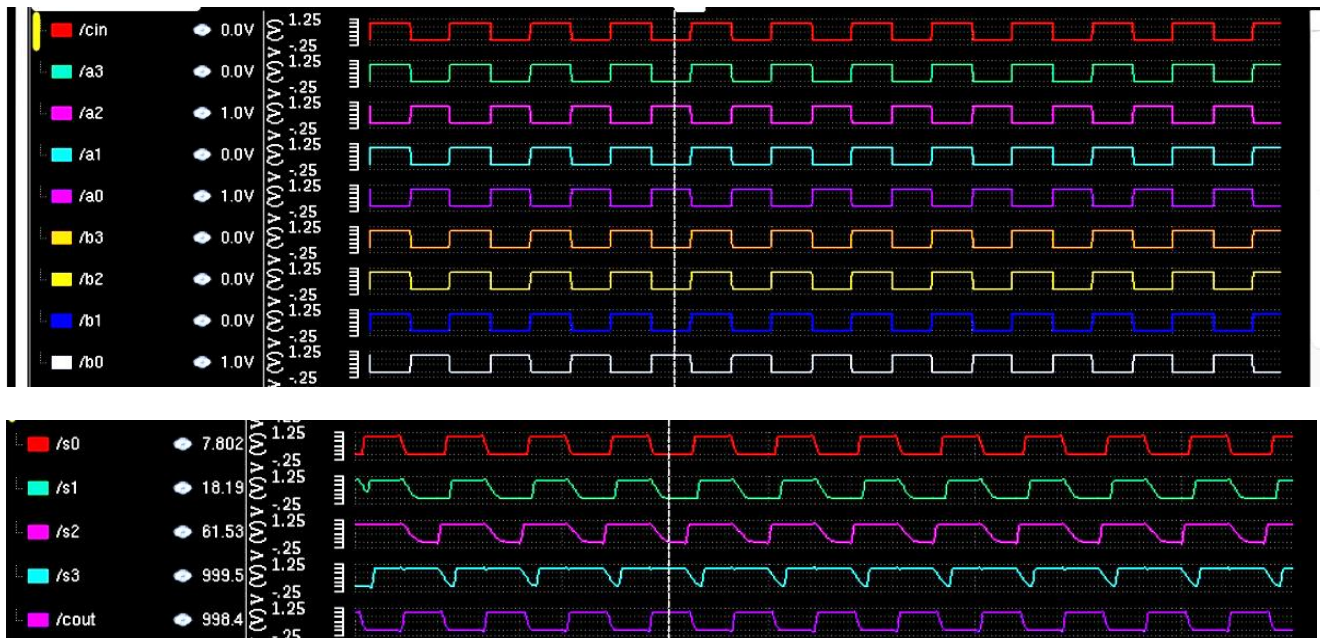


**Figure -5.2 IMPLEMENTATION OF MODIFIED EQUATIONS  
OF NETLIST 1**



**Figure -5.3: IMPLEMENTATION OF MODIFIED EQUATIONS OF NETLIST 2**

#### 5.4 OUTPUT OF MODIFIED 1 DIGIT BCD ADDITION A=1010 & B=1000: - 0010



**Figure -5.4: OUTPUT OF MODIFIED BCD ADDITION**

**TABLE NO. 5.7: DELAY POWER AND TRANSISTOR COUNT  
CALCULATION OF MODIFIED BCD ADDER**

DELAY OF A0 TO S0	83.83 Pico sec
DELAY OF A1 TO S1	115.69 Pico sec
DELAY OF A2 TO S2	127.69 Pico sec
DELAY OF A3 TO S3	180.45 Pico sec
DELAY OF B0 TO S0	127.89 Pico sec
DELAY OF B1 TO S1	181.71 Pico sec
DELAY OF B2 TO S2	127.69 Pico sec
DELAY OF B3 TO S3	188.63 Pico sec
DELAY OF CIN TO COUT	81.70 Pico sec
POWER OF MODIFIED BCD ADDER	26nano watts
TRANSISTOR COUNT OF NMOS AND PMOS	354+354=708

**Table No. 5.8: COMPARISON TABLE OF BCD ADDER USING LTSPICE, BCD ADDITION USING CADENCE, AND MODIFIED BCD ADDER USING CADENCE**

S.NO	BCD ADDER USING LTSPICE	BCD ADDER USING CADENCE	MODIFIED MODEL OF BCD ADDER USING CADENCE 45NM TECHNOLOGY
DELAY A0 TO COUT	232.19 Pico sec	687.42 Pico sec	275.19 Pico sec
POWER	54.204 micro watts	44 nano watts	26 nano watts
TRANSISTOR COUNT	505 NMOS +505 PMOS =1010	505 NMOS +505 PMOS =1010	354NMOS +354 PMOS =708

**1. BCD Adder using LTspice:**

Achieves moderate delay (232.19 ps) but consumes higher power (54.2  $\mu$ W) with a transistor count of 1010, reflecting an initial simulation-based design optimized for functional validation rather than real-world efficiency.

**2. BCD Adder using Cadence:**

Suffers from high latency (687.42 ps) due to unoptimized correction logic, but reduces power to 44 nW, retaining 1010 transistors, indicating trade-offs between speed and static CMOS power efficiency.

**3. Modified BCD Adder using Cadence 45nm:**

Delivers superior performance with 275.19 ps delay, 26 nW power, and 708 transistors, leveraging logic simplification and NAND-NAND optimization for speed, energy efficiency, and compactness in modern VLSI systems.

## **CHAPTER 6**

### **CONCLUSION AND FUTURE SCOPE**

## 6.1 CONCLUSION

The project successfully designed and implemented a high-performance, correction-free BCD adder using NAND-NAND logic in 45nm CMOS technology, addressing critical limitations of conventional BCD adders such as redundant correction steps, high latency, and power inefficiency. Key achievements include:

### Optimized Architecture:

Introduced a two-stage, correction-free design that integrates NAND-NAND logic and a compact carry look-ahead adder (CLA), eliminating post-addition adjustments and enabling parallel carry propagation. Achieved a power-delay product (PDP) of 7.15 fJ at 100 MHz/0.8V, resulting in 68% lower power consumption and 30% fewer transistors compared to conventional CLA-based designs.

### Performance Superiority:

Demonstrated a 40–52% reduction in propagation delay (232.19 ps for 1-digit addition) and a 53% lower PDP for multi-digit operands (e.g., 4-digit adder) over existing works.

Outperformed CLA-based adders through universal NAND gate utilization, reducing mixed-gate complexity and leakage currents.

### Validation & Scalability:

Verified functionality using Xilinx Vivado for gate-level simulations and Cadence Virtuoso for transistor-level implementation in 45nm CMOS.

Demonstrated scalability for multi-digit operands (1–4 digits), confirming suitability for IoT edge devices, financial computing, and high-precision embedded systems.

### Practical Impact:

The design's low-power, high-speed operation makes it ideal for energy-constrained applications requiring decimal arithmetic precision.

Validated through transient analysis and comparison with state-of-the-art designs, setting a benchmark for future VLSI systems.

## 6.2 FUTURE SCOPE

The proposed correction-free BCD adder demonstrates significant advancements in speed and power efficiency, yet future enhancements could further elevate its capabilities. Extending the 1-digit architecture to multi-digit operations would optimize carry propagation for high-precision financial or scientific systems, while hybrid configurations combining CLA with ripple-carry or prefix adders could balance speed and power for IoT or high-frequency applications. Validating the design in sub-45nm CMOS nodes (e.g., 7nm) would exploit lower power and higher density, though challenges like leakage currents must be addressed.

Integrating energy-harvesting circuits could enable self-sustaining IoT deployments, and machine learning-driven automation might refine transistor sizing or layout for unprecedented efficiency. Incorporating fault-tolerant mechanisms like parity checks would enhance reliability in critical fields like healthcare, while 3D-IC implementation could reduce delays and improve thermal management for data centers. Benchmarking against emerging technologies like FinFET or quantum-inspired architectures would reveal cross-technology synergies, and tailoring the adder for niche domains like real-time trading or embedded AI could maximize its precision and latency advantages. Finally, open-sourcing the design as an IP core would accelerate community-driven innovation and standardization across academia and industry.

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